

<b>PCN Number:</b>	20191003004	<b>PCN Date:</b>	Oct. 7, 2019
<b>Title:</b>	Datasheet for TLV9001, TLV9002, TLV9004		
<b>Customer Contact:</b>	PCN Manager	<b>Dept:</b>	Quality Services
<b>Change Type:</b>			
<input type="checkbox"/>	Assembly Site	<input type="checkbox"/>	Design
<input type="checkbox"/>	Assembly Process	<input checked="" type="checkbox"/>	Data Sheet
<input type="checkbox"/>	Assembly Materials	<input type="checkbox"/>	Part number change
<input type="checkbox"/>	Mechanical Specification	<input type="checkbox"/>	Test Site
<input type="checkbox"/>	Packing/Shipping/Labeling	<input type="checkbox"/>	Test Process
<input type="checkbox"/>		<input type="checkbox"/>	Wafer Bump Site
<input type="checkbox"/>		<input type="checkbox"/>	Wafer Bump Material
<input type="checkbox"/>		<input type="checkbox"/>	Wafer Bump Process
<input type="checkbox"/>		<input type="checkbox"/>	Wafer Fab Site
<input type="checkbox"/>		<input type="checkbox"/>	Wafer Fab Materials
<input type="checkbox"/>		<input type="checkbox"/>	Wafer Fab Process

### Notification Details

#### Description of Change:

Texas Instruments Incorporated is announcing an information only notification. The product datasheet(s) is being updated as summarized below. The following change history provides further details.



**TLV9001, TLV9002, TLV9004**

SBOS833M – OCTOBER 2017 – REVISED SEPTEMBER 2019

#### Changes from Revision L (May 2019) to Revision M

**Page**

Deleted preview notations for SOT-23-8 (DDF) package.....	5
Added link to <i>Shutdown</i> section in all SHDN pin function rows .....	7
Added <i>EMI Rejection</i> section to the <i>Feature Description</i> section .....	25
Changed the <i>Shutdown</i> section to add more clarity regarding internal pull-up resistor .....	26

The datasheet number will be changing.

Device Family	Change From:	Change To:
TLV9001, TLV9002, TLV9004	SBOS833L	SBOS833M

These changes may be reviewed at the datasheet links provided.

<http://www.ti.com/product/TLV9001>

#### Reason for Change:

To accurately reflect device characteristics.

#### Anticipated impact on Fit, Form, Function, Quality or Reliability (positive / negative):

No anticipated impact. This is a specification change announcement only. There are no changes to the actual device.

#### Changes to product identification resulting from this PCN:

None.

#### Product Affected:

PTLV9002IDDFR	TLV9001IDBVR	TLV9001IDCKR	TLV9001IDPWR
TLV9001SIDBVR	TLV9001TIDCKR	TLV9001UIDBVR	TLV9002IDDFR
TLV9002IDGKR	TLV9002IDGKT	TLV9002IDR	TLV9002IDSGR
TLV9002IDSGT	TLV9002IPWR	TLV9002SIDGSR	TLV9002SIRUGR
TLV9004IDR	TLV9004IPWR	TLV9004IRTER	TLV9004IRUCR
TLV9004SIRTER			

For questions regarding this notice, e-mails can be sent to the contacts shown below or your local Field Sales Representative.

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Asia Pacific	<a href="mailto:PCNAsiaContact@list.ti.com">PCNAsiaContact@list.ti.com</a>
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